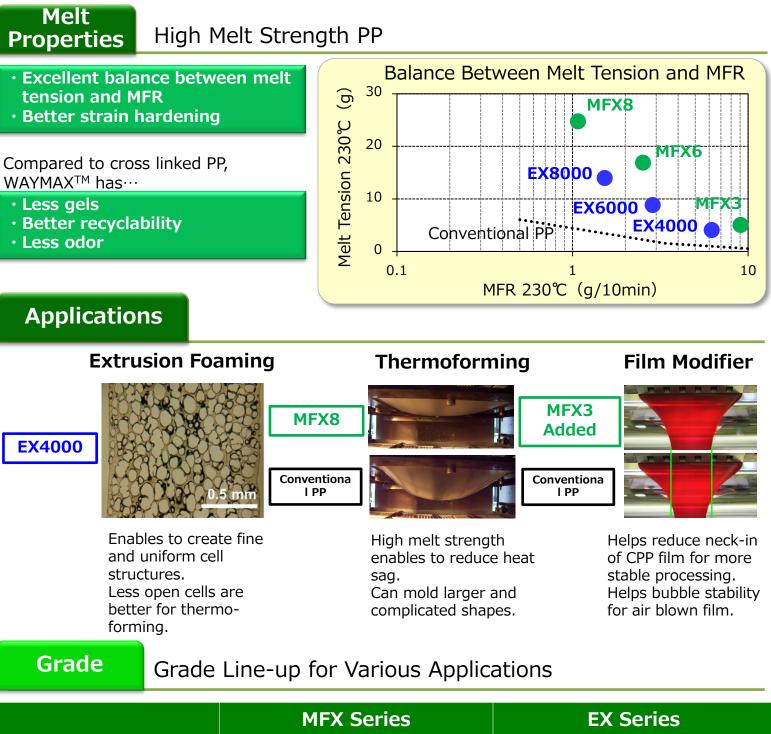
WAYMAXTM for Extrusion Foaming and Modifiers





		MFX8	MFX6	MFX3	EX8000	EX6000	EX4000
Modifier		Thermoforming		Film	Thermoforming		-
Expansion Ratio for Foam		High	High	Low	High	High	Low
MFR (230℃)	g/10min	1.0	2.5	9.0	1.5	2.5	6.0
Melt Tension 230℃	g	24	18	5	14	9	4
Tensile Modulus	MPa	1,900	2,000	1,900	1,500	1,600	1,500
Charpy Impact Strength (23°C)	kJ/m²	4	4	4	15	10	9

This data is based on accumulated experience and tests done at JPP's laboratory, and may not apply to final products produced under different conditions. We cannot guarantee that this data can be directly used for customer's final products or requirements, and therefore, it is the customer's own responsibility to test and judge the conformity and usage. In any case of using our products, we will not guarantee the conformity, marketability, and safety of the customer's final product. In any case of using our products, we will not guarantee that there are no infringements of third party's intellectual property rights, and it is the customer's responsibility to check these rights.

Japan Polypropylene Corporation